Specification of Thermoelectric Module

TES1-12740

Description

The 127 couples, 30 mm x 30 mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70°C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control

Hot side: Th

• Exceptionally reliable in quality, high performance

Application

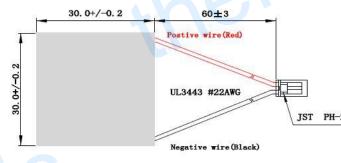
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U _{max} (Voltage)	15.9	17.2	Voltage applied to the module at DT _{max}
I _{max} (Amps)	4	4	DC current through the modules at DT _{max}
Q _{Cmax} (Watts)	40.3	43.4	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (Ohms)	3.0	3.3	The module resistance is tested under AC
Tolerance (%)	± 10		For thermal and electricity parameters

Geometric Characteristics Dimensions in millimeters

Manufacturing Options



See ordering option

See ordering option

See ordering option A

- 1. T100: BiSn (Tmelt=138°C)
 - - ,
- 1. NS: No sealing (Standard)
- 2. T200: CuAgSn (Tmelt = 217°C)
- 2. SS: Silicone sealant

B. Sealant:

- <u>PH-2</u> 3. T240: SbSn (Tmelt = 240°C)
- 3. EPS: Epoxy sealant

C. Ceramics:

A. Solder:

- 1. Alumina (Al₂O₃, white 96%)
- 1. Blank ceramics (not metalized)

D. Ceramics Surface Options:

- 2. Aluminum Nitride (AlN)
- 2. Metalized

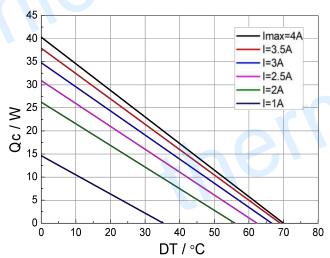
Ordering Option

Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:3.2± 0.1	0: 0.07/0.07	60±3/Specify

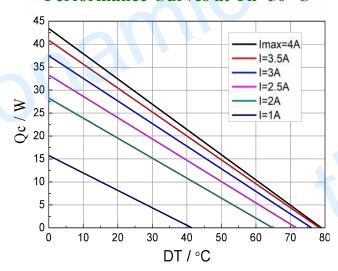
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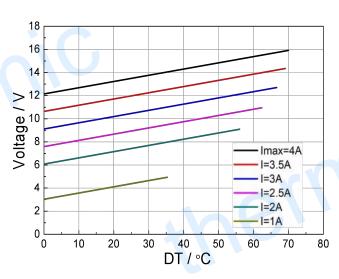


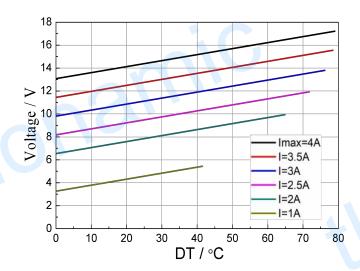


Performance Curves at Th=50 °C

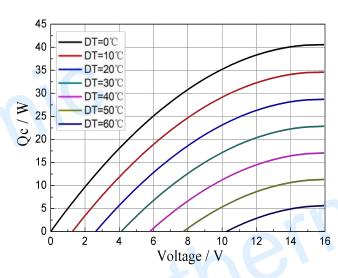


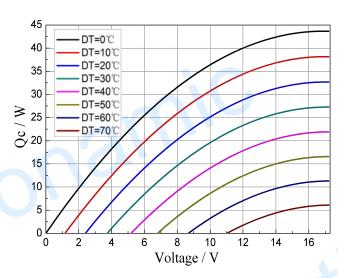
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V= f(DT)





Standard Performance Graph Qc = f(V)

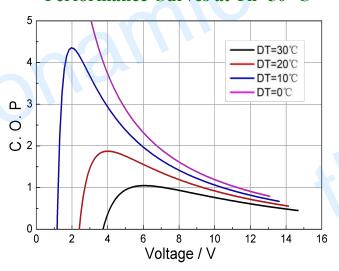
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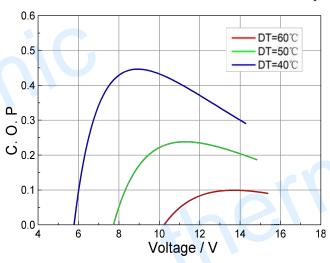


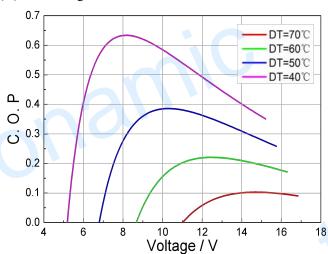
DT=30°C DT=20°C DT=10°C DT=0°C DT=0°C Voltage / V

Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Caution

- Cold side of the module sticked on the object being cooled
- Hot side of the module mounted on a heat radiator
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.